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August 19, 2005 Signature: \_\_\_\_\_

(James P. Zeller)

Docket No.: 29936/39433  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Sung Hoon Lee

Application No.: 10/631,238

Confirmation No.: 1737

Filed: July 31, 2003

Art Unit: 1765

For: METHOD OF FORMING AN ISOLATION  
FILM IN A SEMICONDUCTOR DEVICE

Examiner: Lan Vinh

**AMENDMENT "A"**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the official action of May 26, 2005, please amend the above-identified U.S. patent application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 5 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.